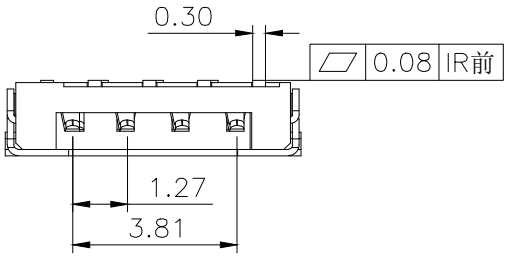
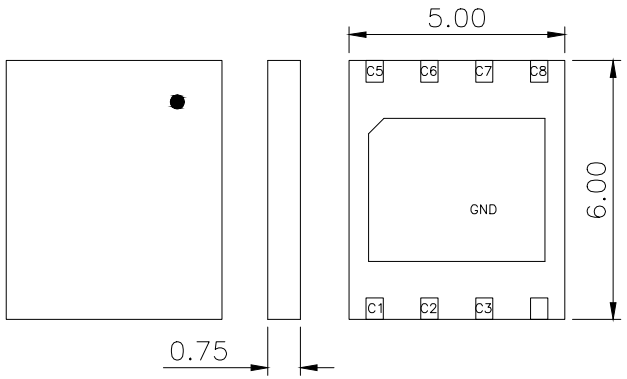
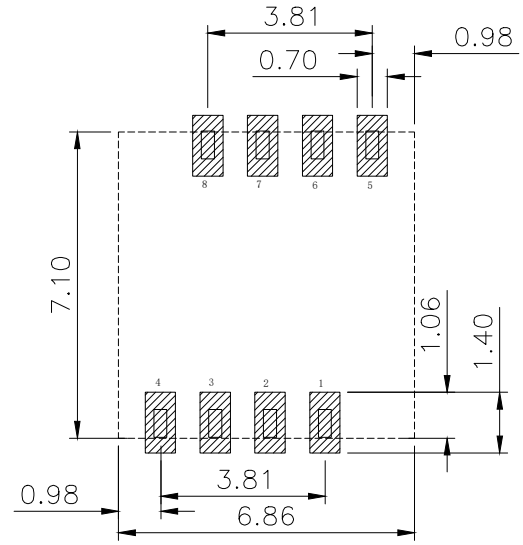
REV.	ECN.NO.	MODIFY.CONTENT	DATE
A0		NEW	2021/05/28

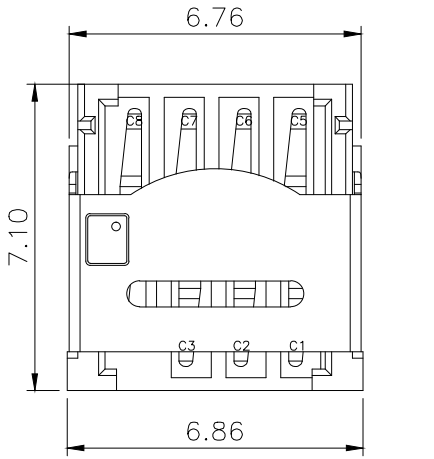


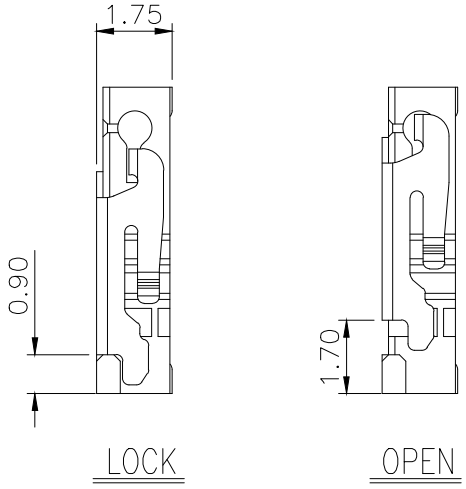


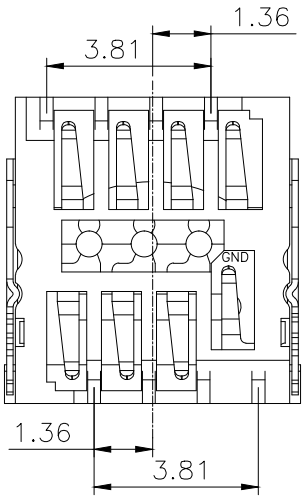


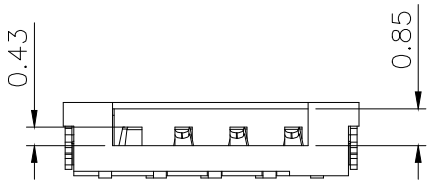
CIRCUT TRACE KEEP OUT AREA
SMT SOLDER AREA
THERE SHOULD NOT BE ANY CIRCUITRIES IN THE LAYOUT SPACE OF THE PRODUCTS.

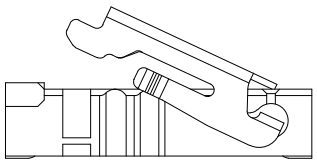
RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05

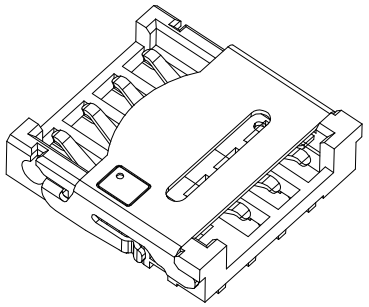


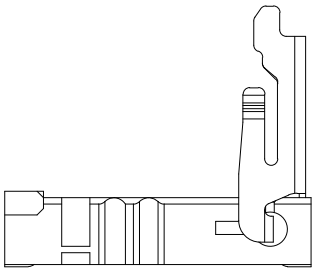












1)MATERIAL:
1.1 HOUSING:LCP,UL94-V0,COLOR:BLACK
1.2 0CONTACT:C5210-H
1.3 SHELL:SUS304-H
2)FINISH:
2.1 TERMINAL:50 u" Min.NICKEL PLATED OVERALL
2.2 CONTACT:GOLD FLASH PLATED ON CONTACT AREA;
GOLD FLASH PLATED ON SOLDER TAILS;
3)ELECTRICAL CHARACTERISTICS
RATING CURRENT : 0.5A MAX.
CONTACT RESISTANCE :50 mΩ MAX
DIELECTRIC WITHSTANDING : 500V AC MIN.
INSULATION RESISTANCE: 1000 MΩ MIN.

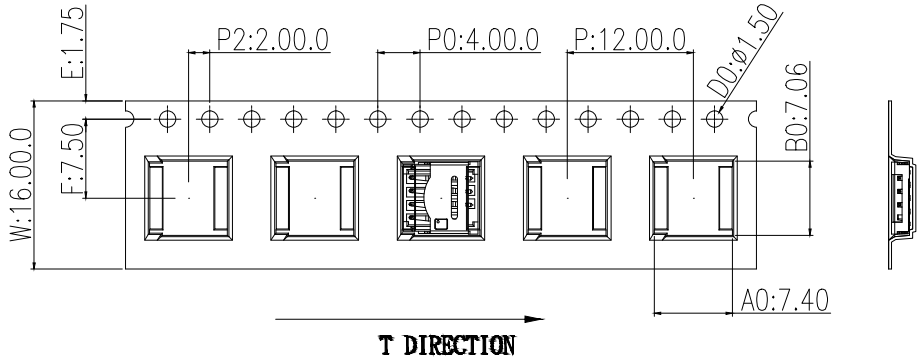
序号	触点信号	解释
1	VSS	接地
2	NULL	未定义
3	I/O	数据输入/数据端口
4	NULL	未定义
5	NULL	未定义
6	CLK	时钟信号输入端
7	RST	复位信号输入端
8	VDD	供电电压输入端

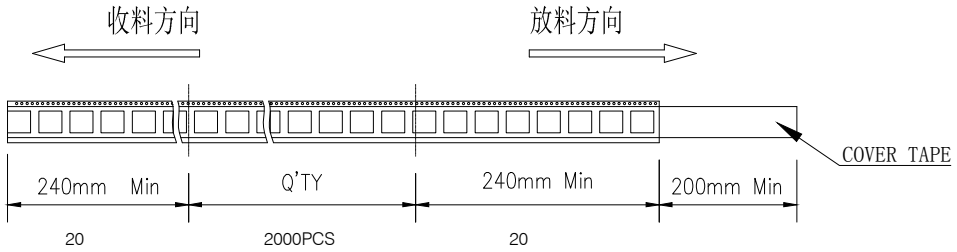
GENERAL TOLERANCE		DWG NO.		APPD:		Scale	1:1
X.±0.45	x.°±5°	Title	1.75H E SIM CARD 8PIN 掀盖式	CHKD:		UNIT	mm
.X±0.35	.x°±2°			DR:	Peng		
.XX±0.25	.xx°±1°	Part NO.	5001B-ESIM175-199	Date	2021/05/28		
.XXX±0.15	.xxx°±0.5°						
SHEET 1/2							

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REV.	ECN.NO.	MODIFY.CONTENT	DATE
A0		NEW	2021.03.05

〈图一〉

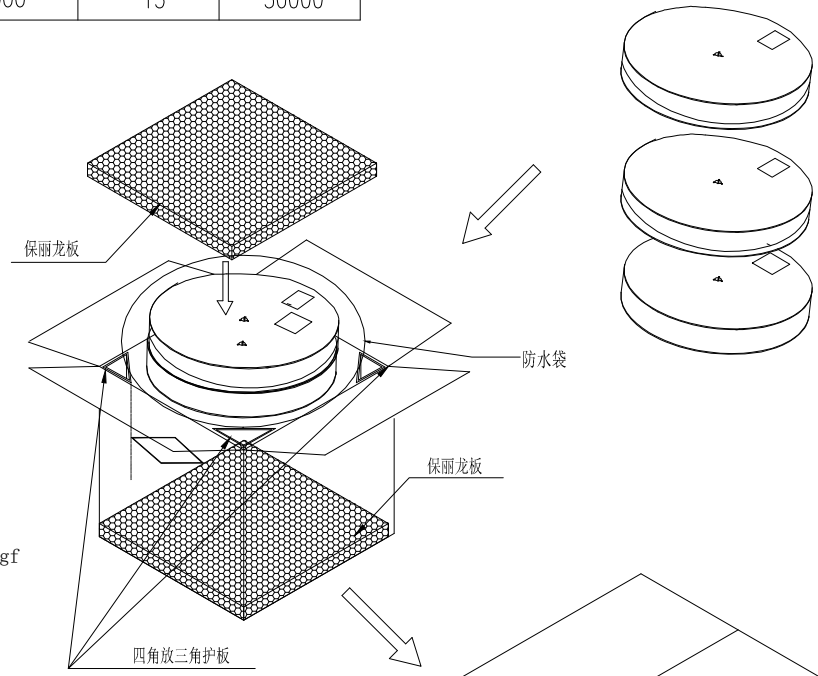


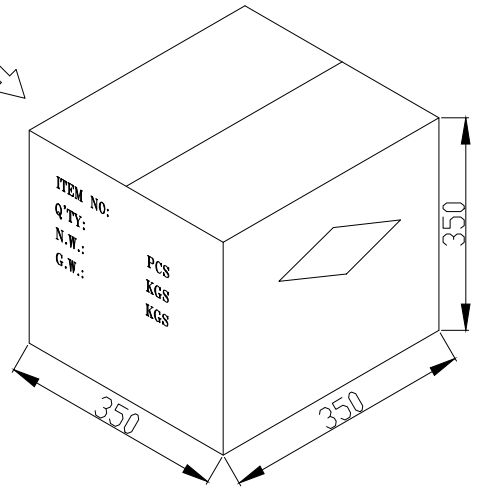


〈TABLE 1〉 PACKAGING QUANTITY

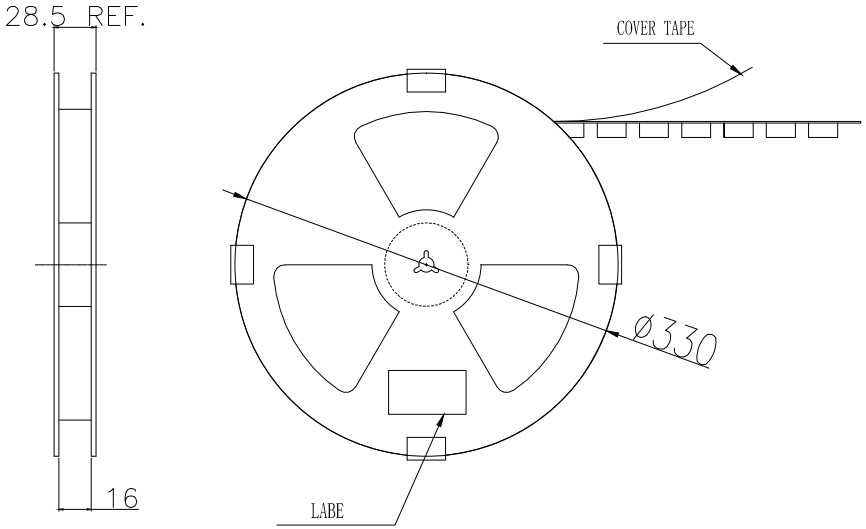
QTY/REEL	REEL/CARTON	QTY/CARTON
2000	15	30000

〈图三〉

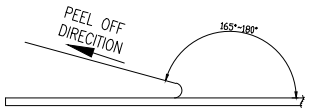




〈图二〉



COVER TAPE PEELING FORCE:20gf~100gf



NOTE:

1. 依〈图一〉示放置产品于下载中,每穴放置1PCS产品.
2. 包装机包好后,在REEL的个等分点贴上胶带,以防止REEL张开,
   每REEL贴1PCS标签,如〈图二〉示
3. 包装数量见如〈TABLE 1〉示
4. 包装成箱见如〈图三〉示
   箱底放保丽龙板,再依次将指定数量的卷装产品用防水袋包好放入箱内,
   四角分别放入四个三角护板,最上层再放上保丽龙板.
5. 封箱,在封好的纸箱上按客户要求写上料号,数量等

GENERAL TOLERANCE		图号		设计	Peng	比例	1:1
X.±0.45	x.°±5°	品名	1.75H E SIM CARD 8PIN 掀盖式包装图	审核		单位	mm
.X±0.35	.x°±2°			核准			
.XX±0.25	.xx°±1°	料号	5001B-ESIM175-199	日期	2021/03/05		
.XXX±0.15	.xxx°±0.5°						
页号	2/2						

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